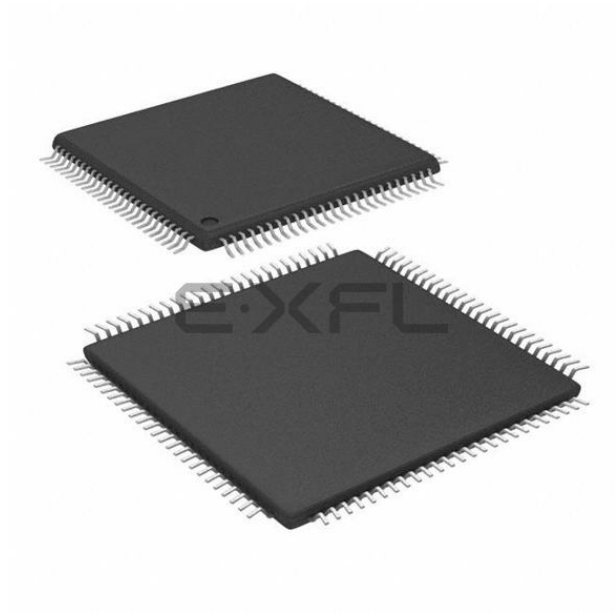
Microchip Technology - PIC32MZ1024EFH100T-I/PT Datasheet



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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

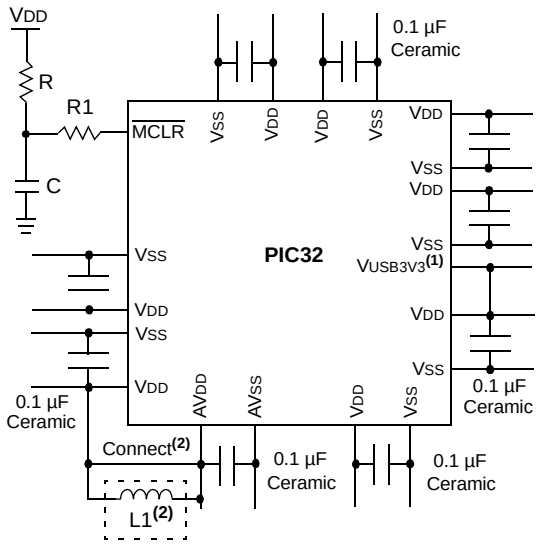
Details	
Product Status	Active
Core Processor	MIPS32® M-Class
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I²C, PMP, SPI, SQI, UART/USART, USB OTG
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	78
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	2.1V ~ 3.6V
Data Converters	A/D 40x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mz1024efh100t-i-pt

TABLE 1-6: PORTA THROUGH PORTK PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number				Pin Type	Buffer Type	Description
	64-pin QFN/ TQFP	100-pin TQFP	124-pin VTLA	144-pin TQFP/ LQFP			
PORTD							
RD0	46	71	A48	104	I/O	ST	PORTD is a bidirectional I/O port
RD1	49	76	A52	109	I/O	ST	
RD2	50	77	B42	110	I/O	ST	
RD3	51	78	A53	111	I/O	ST	
RD4	52	81	A56	118	I/O	ST	
RD5	53	82	B46	119	I/O	ST	
RD6	—	—	A57	120	I/O	ST	
RD7	—	—	B47	121	I/O	ST	
RD9	43	68	B38	97	I/O	ST	
RD10	44	69	A46	98	I/O	ST	
RD11	45	70	B39	99	I/O	ST	
RD12	—	79	B43	112	I/O	ST	
RD13	—	80	A54	113	I/O	ST	
RD14	—	47	B27	69	I/O	ST	
RD15	—	48	A32	70	I/O	ST	
PORTE							
RE0	58	91	B52	135	I/O	ST	PORTE is a bidirectional I/O port
RE1	61	94	A64	138	I/O	ST	
RE2	62	98	A66	142	I/O	ST	
RE3	63	99	B56	143	I/O	ST	
RE4	64	100	A67	144	I/O	ST	
RE5	1	3	A3	3	I/O	ST	
RE6	2	4	B2	4	I/O	ST	
RE7	3	5	A4	5	I/O	ST	
RE8	—	18	B10	23	I/O	ST	
RE9	—	19	A12	24	I/O	ST	
PORTF							
RF0	56	85	A59	124	I/O	ST	PORTF is a bidirectional I/O port
RF1	57	86	B49	125	I/O	ST	
RF2	—	57	B31	79	I/O	ST	
RF3	38	56	A38	78	I/O	ST	
RF4	41	64	B36	90	I/O	ST	
RF5	42	65	A44	91	I/O	ST	
RF8	—	58	A39	80	I/O	ST	
RF12	—	40	B22	58	I/O	ST	
RF13	—	39	A26	57	I/O	ST	

Legend: CMOS = CMOS-compatible input or output; Analog = Analog input; P = Power
ST = Schmitt Trigger input with CMOS levels; O = Output; I = Input
TTL = Transistor-transistor Logic input buffer; PPS = Peripheral Pin Select

FIGURE 2-1: RECOMMENDED MINIMUM CONNECTION



Note 1: If the USB module is not used, this pin must be connected to VSS.

2: As an option, instead of a hard-wired connection, an inductor (L1) can be substituted between VDD and AVDD to improve ADC noise rejection. The inductor impedance should be less than 1Ω and the inductor capacity greater than 10 mA.

Where:

$$f = \frac{FCNV}{2} \quad \text{(i.e., ADC conversion rate/2)}$$

$$f = \frac{1}{(2\pi\sqrt{LC})}$$

$$L = \left(\frac{1}{(2\pi f\sqrt{C})}\right)^2$$

2.2.1 BULK CAPACITORS

The use of a bulk capacitor is recommended to improve power supply stability. Typical values range from 4.7 µF to 47 µF. This capacitor should be located as close to the device as possible.

2.3 Master Clear (MCLR) Pin

The MCLR pin provides for two specific device functions:

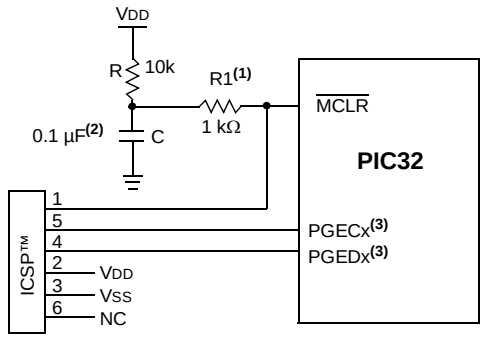
- Device Reset
- Device programming and debugging

Pulling The MCLR pin low generates either a device Reset or a POR, depending on the setting of the SMCLR bit (DEVCFG0<15>). Figure 2-2 illustrates a typical MCLR circuit. During device programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R and C will need to be adjusted based on the application and PCB requirements.

For example, as illustrated in Figure 2-2, it is recommended that the capacitor C be isolated from the MCLR pin during programming and debugging operations.

Place the components illustrated in Figure 2-2 within one-quarter inch (6 mm) from the MCLR pin.

FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS



Note 1: 470Ω ≤ R1 ≤ 1kΩ will limit any current flowing into MCLR from the external capacitor C, in the event of MCLR pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS). Ensure that the MCLR pin VIH and VIL specifications are met without interfering with the Debug/Programmer tools.

2: The capacitor can be sized to prevent unintentional Resets from brief glitches or to extend the device Reset period during POR.

3: No pull-ups or bypass capacitors are allowed on active debug/program PGECx/PGEDx pins.

3.1.4 FLOATING POINT UNIT (FPU)

The Floating Point Unit (FPU), Coprocessor (CP1), implements the MIPS Instruction Set Architecture for floating point computation. The implementation supports the ANSI/IEEE Standard 754 (IEEE for Binary Floating Point Arithmetic) for 32-bit and 64-bit floating point data formats. The FPU can be programmed to have thirty-two 32-bit or 64-bit floating point registers used for floating point operations.

The performance is optimized for 32-bit formats. Most instructions have one FPU cycle throughput and four FPU cycle latency. The FPU implements the multiply-add (MADD) and multiply-sub (MSUB) instructions with intermediate rounding after the multiply function. The result is guaranteed to be the same as executing a MUL and an ADD instruction separately, but the instruction latency, instruction fetch, dispatch bandwidth, and the total number of register accesses are improved.

IEEE denormalized input operands and results are supported by hardware for some instructions. IEEE denormalized results are not supported by hardware in general, but a fast flush-to-zero mode is provided to optimize performance. The fast flush-to-zero mode is enabled through the FCCR register, and use of this mode is recommended for best performance when denormalized results are generated.

The FPU has a separate pipeline for floating point instruction execution. This pipeline operates in parallel with the integer core pipeline and does not stall when the integer pipeline stalls. This allows long-running FPU operations, such as divide or square root, to be partially masked by system stalls and/or other integer unit instructions. Arithmetic instructions are always dispatched and completed in order, but loads and stores can complete out of order. The exception model is “precise” at all times.

Table 3-4 contains the floating point instruction latencies and repeat rates for the processor core. In this table, 'Latency' refers to the number of FPU cycles necessary for the first instruction to produce the result needed by the second instruction. The “Repeat Rate” refers to the maximum rate at which an instruction can be executed per FPU cycle.

TABLE 3-4: FPU INSTRUCTION LATENCIES AND REPEAT RATES

Op code	Latency (FPU Cycles)	Repeat Rate (FPU Cycles)
ABS.[S,D], NEG.[S,D], ADD.[S,D], SUB.[S,D], C.cond.[S,D], MUL.S	4	1
MADD.S, MSUB.S, NMADD.S, NMSUB.S, CABS.cond.[S,D]	4	1
CVT.D.S, CVT.PS.PW, CVT.[S,D].[W,L]	4	1
CVT.S.D, CVT.[W,L].[S,D], CEIL.[W,L].[S,D], FLOOR.[W,L].[S,D], ROUND.[W,L].[S,D], TRUNC.[W,L].[S,D]	4	1
MOV.[S,D], MOVF.[S,D], MOVN.[S,D], MOVT.[S,D], MOVZ.[S,D]	4	1
MUL.D	5	2
MADD.D, MSUB.D, NMADD.D, NMSUB.D	5	2
RECIP.S	13	10
RECIP.D	26	21
RSQRT.S	17	14
RSQRT.D	36	31
DIV.S, SQRT.S	17	14
DIV.D, SQRT.D	32	29
MTC1, DMTC1, LWC1, LDC1, LDXC1, LUXC1, LWXC1	4	1
MFC1, DMFC1, SWC1, SDC1, SDXC1, SUXC1, SWXC1	1	1

Legend: S = Single (32-bit) D = Double (64-bit) W = Word (32-bit) L = Long word (64-bit)

4.1.1 BOOT FLASH SEQUENCE AND CONFIGURATION SPACES

Sequence space is used to identify which boot Flash is aliased by aliased regions. If the value programmed into the TSEQ<15:0> bits of the BF1SEQ3 word is equal to or greater than the value programmed into the TSEQ<15:0> bits of the BF2SEQ3 word, boot Flash 1 is aliased by the lower boot alias region, and boot Flash 2 is aliased by the upper boot alias region. If the TSEQ<15:0> bits of the BF2SEQ3 word is greater than the TSEQ<15:0> bits of the BF1SEQ3 word, the opposite is true (see Table 4-2 and Table 4-3 for BFxSEQ3 word memory locations).

The CSEQ<15:0> bits must contain the one's complement value of the TSEQ<15:0> bits; otherwise, the value of the TSEQ<15:0> bits is considered invalid, and an alternate sequence is used. See **Section 4.1.2 "Alternate Sequence and Configuration Words"** for more information.

Once boot Flash memories are aliased, configuration space located in the lower boot alias region is used as the basis for the Configuration words, DEVSIGN0, DEVCP0, and DEVCFGx (and the associated alternate configuration registers). This means that the boot Flash region to be aliased by lower boot alias region memory must contain configuration values in the appropriate memory locations.

Note:	Do not use word program operation (NVMOP<3:0> = `0001`) when programming data into the sequence and configuration spaces.

4.1.2 ALTERNATE SEQUENCE AND CONFIGURATION WORDS

Every word in the configuration space and sequence space has an associated alternate word (designated by the letter A as the first letter in the name of the word). During device start-up, primary words are read and if uncorrectable ECC errors are found, the BCFGERR (RCON<27>) flag is set and alternate words are used. If uncorrectable ECC errors are found in primary and alternate words, the BCFGFAIL (RCON<26>) flag is set and the default configuration is used.

TABLE 4-6: SYSTEM BUS TARGETS AND ASSOCIATED PROTECTION REGISTERS (CONTINUED)

Target Number	Target Description[5]	SBTxREGy Register							SBTxRDy Register		SBTxWRy Register	
		Name	Region Base (BASE<21:0>) (see Note 2)	Physical Start Address	Region Size (SIZE<4:0>) (see Note 3)	Region Size	Priority (PRI)	Priority Level	Name	Read Permission (GROUP3, GROUP2, GROUP1, GROUP0)	Name	Write Permission (GROUP3, GROUP2, GROUP1, GROUP0)
6	**Peripheral Set 2:** SPI1-SPI6 I2C1-I2C5 UART1-UART6 PMP	SBT6REG0	R	0x1F820000	R	64 KB	—	0	SBT6RD0	R/W[1]	SBT6WR0	R/W[1]
		SBT6REG1	R/W	R/W	R/W	R/W	—	3	SBT6RD1	R/W[1]	SBT6WR1	R/W[1]
7	**Peripheral Set 3:** Timer1-Timer9 IC1-IC9 OC1-OC9 ADC Comparator 1 Comparator 2	SBT7REG0	R	0x1F840000	R	64 KB	—	0	SBT7RD0	R/W[1]	SBT7WR0	R/W[1]
		SBT7REG1	R/W	R/W	R/W	R/W	—	3	SBT7RD1	R/W[1]	SBT7WR1	R/W[1]
8	**Peripheral Set 4:** PORTA-PORTK	SBT8REG0	R	0x1F860000	R	64 KB	—	0	SBT8RD0	R/W[1]	SBT8WR0	R/W[1]
		SBT8REG1	R/W	R/W	R/W	R/W	—	3	SBT8RD1	R/W[1]	SBT8WR1	R/W[1]
9	**Peripheral Set 5:** CAN1 CAN2 Ethernet Controller	SBT9REG0	R	0x1F880000	R	64 KB	—	0	SBT9RD0	R/W[1]	SBT9WR0	R/W[1]
		SBT9REG1	R/W	R/W	R/W	R/W	—	3	SBT9RD1	R/W[1]	SBT9WR1	R/W[1]
10	**Peripheral Set 6:** USB	SBT10REG0	R	0x1F8E3000	R	4 KB	—	0	SBT10RD0	R/W[1]	SBT10WR0	R/W[1]
11	External Memory via SQI1 and SQI1 Module	SBT11REG0	R	0x30000000	R	64 MB	—	0	SBT11RD0	R/W[1]	SBT11WR0	R/W[1]
		SBT11REG1	R	0x1F8E2000	R	4 KB	—	3	SBT11RD1	R/W[1]	SBT11WR1	R/W[1]
12	**Peripheral Set 7:** Crypto Engine	SBT12REG0	R	0x1F8E5000	R	4 KB	—	0	SBT12RD0	R/W[1]	SBT12WR0	R/W[1]
13	**Peripheral Set 8:** RNG Module	SBT13REG0	R	0x1F8E6000	R	4 KB	—	0	SBT13RD0	R/W[1]	SBT13WR0	R/W[1]

Legend: R = Read; R/W = Read/Write; 'x' in a register name = 0-13; 'y' in a register name = 0-8.

Note 1: Reset values for these bits are '0', '1', '1', '1', respectively.

2: The BASE<21:0> bits must be set to the corresponding Physical Address and right shifted by 10 bits. For Read-only bits, this value is set by hardware on Reset.

3: The SIZE<4:0> bits must be set to the corresponding Region Size, based on the following formula: Region Size = $2^{(SIZE-1)}$ x 1024 bytes. For read-only bits, this value is set by hardware on Reset.

4: Refer to the Device Memory Maps (Figure 4-1 through Figure 4-4) for specific device memory sizes and start addresses.

5: See Table 4-1for information on specific target memory size and start addresses.

6: The SBTxREG1 SFRs are reserved, and therefore, are not listed in this table for this target.

7.3 Interrupt Control Registers

TABLE 7-3: INTERRUPT REGISTER MAP

Virtual Address (BF81_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
0000	INTCON	31:16	NMIKEY<7:0>								—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	MVEC	—	TPC<2:0>			—	—	—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP	0000
0010	PRISS	31:16	PRI7SS<3:0>				PRI6SS<3:0>				PRI5SS<3:0>				PRI4SS<3:0>				0000
		15:0	PRI3SS<3:0>				PRI2SS<3:0>				PRI1SS<3:0>				—	—	—	SS0	0000
0020	INTSTAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	SRIPL<2:0>			SIRQ<7:0>								0000
0030	IPTMR	31:16	IPTMR<31:0>																0000
		15:0																	0000
0040	IFS0	31:16	OC6IF	IC6IF	IC6EIF	T6IF	OC5IF	IC5IF	IC5EIF	T5IF	INT4IF	OC4IF	IC4IF	IC4EIF	T4IF	INT3IF	OC3IF	IC3IF	0000
		15:0	IC3EIF	T3IF	INT2IF	OC2IF	IC2IF	IC2EIF	T2IF	INT1IF	OC1IF	IC1IF	IC1EIF	T1IF	INT0IF	CS1IF	CS0IF	CTIF	0000
0050	IFS1	31:16	ADCD4IF	ADCD3IF	ADCD2IF	ADCD1IF	ADCD0IF	ADCFLTIF	ADCDF6IF	ADCDF5IF	ADCDF4IF	ADCDF3IF	ADCDF2IF	ADCDF1IF	ADCDC6IF	ADCDC5IF	ADCDC4IF	ADCDC3IF	0000
		15:0	ADCDC2IF	ADCDC1IF	ADCFIFOIF	ADCIF	OC9IF	IC9IF	IC9EIF	T9IF	OC8IF	IC8IF	IC8EIF	T8IF	OC7IF	IC7IF	IC7EIF	T7IF	0000
0060	IFS2(5)	31:16	ADCD36IF	ADCD35IF	ADCD34IF	ADCD33IF	ADCD32IF	ADCD31IF	ADCD30IF	ADCD29IF	ADCD28IF	ADCD27IF	ADCD26IF	ADCD25IF	ADCD24IF	ADCD23IF	ADCD22IF	ADCD21IF	0000
		15:0	ADCD20IF	ADCD19IF	ADCD18IF	ADCD17IF	ADCD16IF	ADCD15IF	ADCD14IF	ADCD13IF	ADCD12IF	ADCD11IF	ADCD10IF	ADCD9IF	ADCD8IF	ADCD7IF	ADCD6IF	ADCD5IF	0000
0070	IFS3(6)	31:16	CNKIF(8)	CNJIF	CNHIF	CNGIF	CNFIF	CNEIF	CNDIF	CNCIF	CNBIF	CNAIF	I2C1MIF	I2C1SIF	I2C1BIF	U1TXIF	U1RXIF	U1EIF	0000
		15:0	SPI1TXIF	SPI1RXIF	SPI1EIF	—	CRPTIF(7)	SBIF	CFDCIF	CPCIF	ADCD44IF	ADCD43IF	ADCD42IF	ADCD41IF	ADCD40IF	ADCD39IF	ADCD38IF	ADCD37IF	0000
0080	IFS4	31:16	U3TXIF	U3RXIF	U3EIF	SPI3TXIF	SPI3RXIF	SPI3EIF	ETHIF	CAN2IF(3)	CAN1IF(3)	I2C2MIF(2)	I2C2SIF(2)	I2C2BIF(2)	U2TXIF	U2RXIF	U2EIF	SPI2TXIF	0000
		15:0	SPI2RXIF	SPI2EIF	DMA7IF	DMA6IF	DMA5IF	DMA4IF	DMA3IF	DMA2IF	DMA1IF	DMA0IF	USBDMAIF	USBIF	CMP2IF	CMP1IF	PMPEIF	PMPIF	0000
0090	IFS5	31:16	—	U6TXIF	U6RXIF	U6EIF	SPI6TX(2)	SPI6RXIF(2)	SPI6IF(2)	I2C5MIF	I2C5SIF	I2C5BIF	U5TXIF	U5RXIF	U5EIF	SPI5TXIF(2)	SPI5RXIF(2)	SPI5EIF(2)	0000
		15:0	I2C4MIF	I2C4SIF	I2C4BIF	U4TXIF	U4RXIF	U4EIF	SQI1IF	PREIF	FCEIF	RTCCIF	SPI4TXIF	SPI4RXIF	SPI4EIF	I2C3MIF	I2C3SIF	I2C3BIF	0000
00A0	IFS6	31:16	—	—	—	—	—	—	—	—	—	—	ADC7WIF	—	—	ADC4WIF	ADC3WIF	ADC2WIF	0000
		15:0	ADC1WIF	ADC0WIF	ADC7EIF	—	—	ADC4EIF	ADC3EIF	ADC2EIF	ADC1EIF	ADC0EIF	—	ADCGRPIF	—	ADCURDYIF	ADCARDYIF	ADCEOSIF	0000
00C0	IEC0	31:16	OC6IE	IC6IE	IC6EIE	T6IE	OC5IE	IC5IE	IC5EIE	T5IE	INT4IE	OC4IE	IC4IE	IC4EIE	T4IE	INT3IE	OC3IE	IC3IE	0000
		15:0	IC3EIE	T3IE	INT2IE	OC2IE	IC2IE	IC2EIE	T2IE	INT1IE	OC1IE	IC1IE	IC1EIE	T1IE	INT0IE	CS1IE	CS0IE	CTIE	0000
00D0	IEC1	31:16	ADCD4IE	ADCD3IE	ADCD2IE	ADCD1IE	ADCD0IE	ADCFLTIE	ADCDF6IE	ADCDF5IE	ADCDF4IE	ADCDF3IE	ADCDF2IE	ADCDF1IE	ADCDC6IE	ADCDC5IE	ADCDC4IE	ADCDC3IE	0000
		15:0	ADCDC2IE	ADCDC1IE	ADCFIFOIE	ADCIE	OC9IE	IC9IE	IC9EIE	T9IE	OC8IE	IC8IE	IC8EIE	T8IE	OC7IE	IC7IE	IC7EIE	T7IE	0000
00E0	IEC2(5)	31:16	ADCD36IE	ADCD35IE	ADCD34IE	ADCD33IE	ADCD32IE	ADCD31IE	ADCD30IE	ADCD29IE	ADCD28IE	ADCD27IE	ADCD26IE	ADCD25IE	ADCD24IE	ADCD23IE	ADCD22IE	ADCD21IE	0000
		15:0	ADCD20IE	ADCD19IE	ADCD18IE	ADCD17IE	ADCD16IE	ADCD15IE	ADCD14IE	ADCD13IE	ADCD12IE	ADCD11IE	ADCD10IE	ADCD9IE	ADCD8IE	ADCD7IE	ADCD6IE	ADCD5IE	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table with the exception of the OFFx registers, have corresponding CLR, SET, and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.
2: This bit or register is not available on 64-pin devices.
3: This bit or register is not available on devices without a CAN module.
4: This bit or register is not available on 100-pin devices.
5: Bits 31 and 30 are not available on 64-pin and 100-pin devices; bits 29 through 14 are not available on 64-pin devices.
6: Bits 31, 30, 29, and bits 5 through 0 are not available on 64-pin and 100-pin devices; bit 31 is not available on 124-pin devices; bit 22 is not available on 64-pin devices.
7: This bit or register is not available on devices without a Crypto module.
8: This bit or register is not available on 124-pin devices.

REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	NMIKEY<7:0>							
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
	—	—	—	MVEC	—	TPC<2:0>		
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	—	—	—	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-24 **NMIKEY<7:0>:** Non-Maskable Interrupt Key bits
When the correct key (0x4E) is written, a software NMI will be generated. The status is indicated by the GNMI bit (RNMICON<19>).

bit 23-13 **Unimplemented:** Read as '0'

bit 12 **MVEC:** Multi Vector Configuration bit
1 = Interrupt controller configured for multi vectored mode
0 = Interrupt controller configured for single vectored mode

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **TPC<2:0>:** Interrupt Proximity Timer Control bits
111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer
110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer
101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer
100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer
011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer
010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer
001 = Interrupts of group priority 1 start the Interrupt Proximity timer
000 = Disables Interrupt Proximity timer

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **INT4EP:** External Interrupt 4 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 3 **INT3EP:** External Interrupt 3 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 2 **INT2EP:** External Interrupt 2 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 1 **INT1EP:** External Interrupt 1 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

bit 0 **INT0EP:** External Interrupt 0 Edge Polarity Control bit
1 = Rising edge
0 = Falling edge

TABLE 10-3: DMA CHANNEL 0 THROUGH CHANNEL 7 REGISTER MAP (CONTINUED)

Virtual Address (BF81_#)	Register Name(1)	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
1280	DCH2CPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHCPTR<15:0>																0000
1290	DCH2DAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHPDAT<15:0>																0000
12A0	DCH3CON	31:16	CHPIGN<7:0>								—	—	—	—	—	—	—	—	0000
		15:0	CHBUSY	—	CHPIGNEN	—	CHPATLEN	—	—	CHCHNS	CHEN	CHAED	CHCHN	CHAEN	—	CHEDET	CHPRI<1:0>		0000
12B0	DCH3ECON	31:16	—	—	—	—	—	—	—	—	CHAIRQ<7:0>								00FF
		15:0	CHSIRQ<7:0>								CFORCE	CABORT	PATEN	SIRQEN	AIRQEN	—	—	—	FF00
12C0	DCH3INT	31:16	—	—	—	—	—	—	—	—	CHSDIE	CHSHIE	CHDDIE	CHDHIE	CHBCIE	CHCCIE	CHTAIE	CHERIE	0000
		15:0	—	—	—	—	—	—	—	—	CHSDIF	CHSHIF	CHDDIF	CHDHIF	CHBCIF	CHCCIF	CHTAIF	CHERIF	0000
12D0	DCH3SSA	31:16	CHSSA<31:0>																0000
		15:0																	0000
12E0	DCH3DSA	31:16	CHDSA<31:0>																0000
		15:0																	0000
12F0	DCH3SSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHSSIZ<15:0>																0000
1300	DCH3DSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHDSIZ<15:0>																0000
1310	DCH3SPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHSPTR<15:0>																0000
1320	DCH3DPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHDPTR<15:0>																0000
1330	DCH3CSIZ	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHCSIZ<15:0>																0000
1340	DCH3CPTR	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHCPTR<15:0>																0000
1350	DCH3DAT	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	CHPDAT<15:0>																0000
1360	DCH4CON	31:16	CHPIGN<7:0>								—	—	—	—	—	—	—	—	0000
		15:0	CHBUSY	—	CHPIGNEN	—	CHPATLEN	—	—	CHCHNS	CHEN	CHAED	CHCHN	CHAEN	—	CHEDET	CHPRI<1:0>		0000
1370	DCH4ECON	31:16	—	—	—	—	—	—	—	—	CHAIRQ<7:0>								00FF
		15:0	CHSIRQ<7:0>								CFORCE	CABORT	PATEN	SIRQEN	AIRQEN	—	—	—	FF00
1380	DCH4INT	31:16	—	—	—	—	—	—	—	—	CHSDIE	CHSHIE	CHDDIE	CHDHIE	CHBCIE	CHCCIE	CHTAIE	CHERIE	0000
		15:0	—	—	—	—	—	—	—	—	CHSDIF	CHSHIF	CHDDIF	CHDHIF	CHBCIF	CHCCIF	CHTAIF	CHERIF	0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.

REGISTER 11-28: USBLPMR1: USB LINK POWER MANAGEMENT CONTROL REGISTER 1 (CONTINUED)

bit 16 **LPMXMT:** LPM Transition to the L1 State bit

When in *Device mode*:

1 = USB module will transition to the L1 state upon the receipt of the next LPM transaction. LPMEN must be set to '0b11. Both LPMXMT and LPMEN must be set in the same cycle.

0 = Maintain current state

When LPMXMT and LPMEN are set, the USB module can respond in the following ways:

- If no data is pending (all TX FIFOs are empty), the USB module will respond with an ACK. The bit will self clear and a software interrupt will be generated.
- If data is pending (data resides in at least one TX FIFO), the USB module will respond with a NYET. In this case, the bit will not self clear however a software interrupt will be generated.

When in *Host mode*:

1 = USB module will transmit an LPM transaction. This bit is self clearing, and will be immediately cleared upon receipt of any Token or three time-outs have occurred.

0 = Maintain current state

bit 15-12 **ENDPOINT<3:0>:** LPM Token Packet Endpoint bits

This is the endpoint in the token packet of the LPM transaction.

bit 11-9 **Unimplemented:** Read as '0'

bit 8 **RMTWAK:** Remote Wake-up Enable bit

This bit is applied on a temporary basis only and is only applied to the current suspend state.

1 = Remote wake-up is enabled

0 = Remote wake-up is disabled

bit 7-4 **HIRD<3:0>:** Host Initiated Resume Duration bits

The minimum time the host will drive resume on the bus. The value in this register corresponds to an actual resume time of:

Resume Time = 50 µs + HIRD * 75 µs. The resulting range is 50 µs to 1200 µs.

bit 3-0 **LNKSTATE<3:0>:** Link State bits

This value is provided by the host to the peripheral to indicate what state the peripheral must transition to after the receipt and acceptance of a LPM transaction. The only valid value for this register is '1' for Sleep State (L1). All other values are reserved.

REGISTER 11-29: USBLPMR2: USB LINK POWER MANAGEMENT CONTROL REGISTER 2 (CONTINUED)

bit 0 **LPMSTIF:** LPM STALL Interrupt Flag bit

When in *Device mode*:

1 = A LPM transaction was received and the USB Module responded with a STALL

0 = No Stall condition

When in *Host mode*:

1 = A LPM transaction was transmitted and the device responded with a STALL

0 = No Stall condition

REGISTER 20-10: SQI1TXDATA: SQI TRANSMIT DATA BUFFER REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXDATA<31:24>							
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXDATA<23:16>							
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXDATA<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	TXDATA<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **TXDATA<31:0>:** Transmit Command Data bits

Data is loaded into this register before being transmitted. Prior to the data transfer, the data in TXDATA is loaded into the shift register (SFDR).

Multiple writes to TXDATA can occur while a transfer is in progress. There can be a maximum of eight commands that can be queued.

REGISTER 20-11: SQI1RXDATA: SQI RECEIVE DATA BUFFER REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	RXDATA<31:24>							
23:16	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	RXDATA<23:16>							
15:8	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	RXDATA<15:8>							
7:0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
	RXDATA<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 **RXDATA<31:0>:** Receive Data Buffer bits

At the end of a data transfer, the data in the shift register is loaded into the RXDATA register. This register works like a FIFO. The depth of the receive buffer is eight words.

22.1 UART Control Registers

TABLE 22-1: UART1 THROUGH UART6 REGISTER MAP

Virtual Address (BF82_#)	Register Name	Bit Range	Bits																All Resets
			31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	
2000	U1MODE(1)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	IREN	RTSMD	—	UEN<1:0>		WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL<1:0>		STSEL	0000
2010	U1STA(1)	31:16	—	—	—	—	—	—	—	ADM_EN	ADDR<7:0>								0000
		15:0	UTXISEL<1:0>		UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL<1:0>		ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
2020	U1TXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	TX8	Transmit Register								0000
2030	U1RXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	RX8	Receive Register								0000
2040	U1BRG(1)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	Baud Rate Generator Prescaler																0000
2200	U2MODE(1)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	IREN	RTSMD	—	UEN<1:0>		WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL<1:0>		STSEL	0000
2210	U2STA(1)	31:16	—	—	—	—	—	—	—	ADM_EN	ADDR<7:0>								0000
		15:0	UTXISEL<1:0>		UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL<1:0>		ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
2220	U2TXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	TX8	Transmit Register								0000
2230	U2RXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	RX8	Receive Register								0000
2240	U2BRG(1)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	Baud Rate Generator Prescaler																0000
2400	U3MODE(1)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	ON	—	SIDL	IREN	RTSMD	—	UEN<1:0>		WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSEL<1:0>		STSEL	0000
2410	U3STA(1)	31:16	—	—	—	—	—	—	—	ADM_EN	ADDR<7:0>								0000
		15:0	UTXISEL<1:0>		UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISEL<1:0>		ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
2420	U3TXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	TX8	Transmit Register								0000
2430	U3RXREG	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	—	—	—	—	—	—	—	RX8	Receive Register								0000
2440	U3BRG(1)	31:16	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
		15:0	Baud Rate Generator Prescaler																0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See **Section 12.3 "CLR, SET, and INV Registers"** for more information.

REGISTER 29-4: CiVEC: CAN INTERRUPT CODE REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	U-0	U-0	U-0	R-0	R-0	R-0	R-0	R-0
	—	—	—	FILHIT<4:0>				
7:0	U-0	R-1	R-0	R-0	R-0	R-0	R-0	R-0
	—	ICODE<6:0>(1)						

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-13 **Unimplemented:** Read as '0'

bit 12-8 **FILHIT<4:0>:** Filter Hit Number bit
11111 = Filter 31
11110 = Filter 30
•
•
•
00001 = Filter 1
00000 = Filter 0

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **ICODE<6:0>:** Interrupt Flag Code bits(1)
1001000-1111111 = Reserved
1001000 = Invalid message received (IVRIF)
1000111 = CAN module mode change (MODIF)
1000110 = CAN timestamp timer (CTMRIF)
1000101 = Bus bandwidth error (SERRIF)
1000100 = Address error interrupt (SERRIF)
1000011 = Receive FIFO overflow interrupt (RBOVIF)
1000010 = Wake-up interrupt (WAKIF)
1000001 = Error Interrupt (CERRIF)
1000000 = No interrupt
0100000-0111111 = Reserved
0011111 = FIFO31 Interrupt (CiFSTAT<31> set)
0011110 = FIFO30 Interrupt (CiFSTAT<30> set)
•
•
•
0000001 = FIFO1 Interrupt (CiFSTAT<1> set)
0000000 = FIFO0 Interrupt (CiFSTAT<0> set)

Note 1: These bits are only updated for enabled interrupts.

REGISTER 29-17: CiFLTCON7: CAN FILTER CONTROL REGISTER 7 (CONTINUED)

bit 15 **FLTEN29:** Filter 29 Enable bit
1 = Filter is enabled
0 = Filter is disabled

bit 14-13 **MSEL29<1:0>:** Filter 29 Mask Select bits
11 = Acceptance Mask 3 selected
10 = Acceptance Mask 2 selected
01 = Acceptance Mask 1 selected
00 = Acceptance Mask 0 selected

bit 12-8 **FSEL29<4:0>:** FIFO Selection bits
11111 = Message matching filter is stored in FIFO buffer 31
11110 = Message matching filter is stored in FIFO buffer 30
•
•
•
00001 = Message matching filter is stored in FIFO buffer 1
00000 = Message matching filter is stored in FIFO buffer 0

bit 7 **FLTEN28:** Filter 28 Enable bit
1 = Filter is enabled
0 = Filter is disabled

bit 6-5 **MSEL28<1:0>:** Filter 28 Mask Select bits
11 = Acceptance Mask 3 selected
10 = Acceptance Mask 2 selected
01 = Acceptance Mask 1 selected
00 = Acceptance Mask 0 selected

bit 4-0 **FSEL28<4:0>:** FIFO Selection bits
11111 = Message matching filter is stored in FIFO buffer 31
11110 = Message matching filter is stored in FIFO buffer 30
•
•
•
00001 = Message matching filter is stored in FIFO buffer 1
00000 = Message matching filter is stored in FIFO buffer 0

Note: The bits in this register can only be modified if the corresponding filter enable (FLTENn) bit is '0'.

REGISTER 30-22: ETHALGNERR: ETHERNET CONTROLLER ALIGNMENT ERRORS STATISTICS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ALGNERRCNT<15:8>							
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	ALGNERRCNT<7:0>							

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-0 **ALGNERRCNT<15:0>:** Alignment Error Count bits

Increment count for frames with alignment errors. Note that an alignment error is a frame that has an FCS error and the frame length in bits is not an integral multiple of 8 bits (a.k.a., dribble nibble)

Note 1: This register is only used for RX operations.

2: This register is automatically cleared by hardware after a read operation, unless the byte enables for bytes 0/1 are '0'.

3: It is recommended to use the SET, CLR, or INV registers to set or clear any bit in this register. Setting or clearing any bits in this register should be only done for debug/test purposes.

REGISTER 30-38: EMAC1SA1: ETHERNET CONTROLLER MAC STATION ADDRESS 1 REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	—	—	—	—	—	—	—	—
15:8	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P
	STNADDR4<7:0>							
7:0	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P	R/W-P
	STNADDR3<7:0>							

Legend:		P = Programmable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15-8 **STNADDR4<7:0>:** Station Address Octet 4 bits
These bits hold the fourth transmitted octet of the station address.

bit 7-0 **STNADDR3<7:0>:** Station Address Octet 3 bits
These bits hold the third transmitted octet of the station address.

Note 1: Both 16-bit and 32-bit accesses are allowed to these registers (including the SET, CLR and INV registers). 8-bit accesses are not allowed and are ignored by the hardware.

2: This register is loaded at reset from the factory preprogrammed station address.

REGISTER 34-8: CFGEBIA: EXTERNAL BUS INTERFACE ADDRESS PIN CONFIGURATION REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
	EBIPINEN	—	—	—	—	—	—	—
23:16	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	EBIA23EN	EBIA22EN	EBIA21EN	EBIA20EN	EBIA19EN	EBIA18EN	EBIA17EN	EBIA16EN
15:8	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	EBIA15EN	EBIA14EN	EBIA13EN	EBIA12EN	EBIA11EN	EBIA10EN	EBIA9EN	EBIA8EN
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
	EBIA7EN	EBIA6EN	EBIA5EN	EBIA4EN	EBIA3EN	EBIA2EN	EBIA1EN	EBIA0EN

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31 **EBIPINEN:** EBI Pin Enable bit
1 = EBI controls access of pins shared with PMP
0 = Pins shared with EBI are available for general use

bit 30-24 **Unimplemented:** Read as '0'

bit 23-0 **EBIA23EN:EBIA0EN:** EBI Address Pin Enable bits
1 = EBIAx pin is enabled for use by EBI
0 = EBIAx pin has is available for general use

Note: When EBIMD = 1, the bits in this register are ignored and the pins are available for general use.

37.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC32MZ EF electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC32MZ EF devices are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions, above the parameters indicated in the operation listings of this specification, is not implied.

Specifications for Extended Temperature devices (-40ºC to +125ºC) that are different from the specifications in this section are provided in **38.0 "Extended Temperature Electrical Characteristics"**.

Absolute Maximum Ratings

(See Note 1)

Ambient temperature under bias ..... -40°C to +85°C
Storage temperature ..... -65°C to +150°C
Voltage on V_{DD} with respect to V_{SS} ..... -0.3V to +4.0V
Voltage on any pin that is not 5V tolerant, with respect to V_{SS} **(Note 3)** ..... -0.3V to (V_{DD} + 0.3V)
Voltage on any 5V tolerant pin with respect to V_{SS} when $V_{DD} \geq 2.1V$ **(Note 3)** ..... -0.3V to +5.5V
Voltage on any 5V tolerant pin with respect to V_{SS} when $V_{DD} < 2.1V$ **(Note 3)** ..... -0.3V to +3.6V
Voltage on D+ or D- pin with respect to V_{USB3V3} ..... -0.3V to (V_{USB3V3} + 0.3V)
Voltage on V_{BUS} with respect to V_{SS} ..... -0.3V to +5.5V
Maximum current out of V_{SS} pin(s) ..... 200 mA
Maximum current into V_{DD} pin(s) **(Note 2)** ..... 200 mA
Maximum current sunk/sourced by any 4x I/O pin **(Note 4)** ..... 15 mA
Maximum current sunk/sourced by any 8x I/O pin **(Note 4)** ..... 25 mA
Maximum current sunk/sourced by any 12x I/O pin **(Note 4)** ..... 33 mA
Maximum current sunk by all ports ..... 150 mA
Maximum current sourced by all ports **(Note 2)** ..... 150 mA

Note 1: Stresses above those listed under **"Absolute Maximum Ratings"** may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions, above those indicated in the operation listings of this specification, is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2: Maximum allowable current is a function of device maximum power dissipation (see Table 37-2).

3: See the pin name tables (Table 2 through Table 4) for the 5V tolerant pins.

4: Characterized, but not tested. Refer to parameters DO10, DO20, and DO20a for the 4x, 8x, and 12x I/O pin lists.

37.2 AC Characteristics and Timing Parameters

The information contained in this section defines PIC32MZ EF device AC characteristics and timing parameters.

FIGURE 37-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

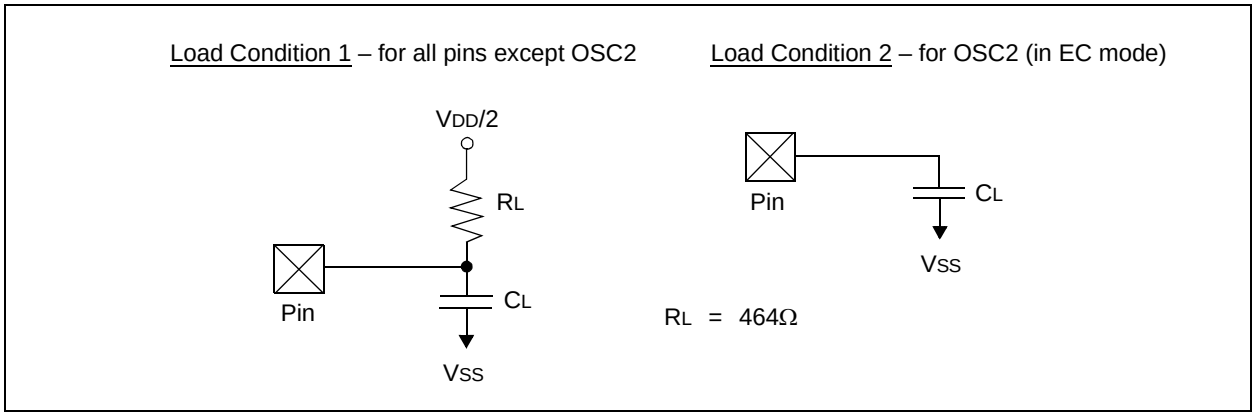


TABLE 37-16: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics**	**Min.**	**Typical(1)**	**Max.**	**Units**	**Conditions**
DO56	CL	All I/O pins (except pins used as CxOUT)	—	—	50	pF	EC mode for OSC2
DO58	CB	SCLx, SDAx	—	—	400	pF	In I^2C mode
DO59	CSQI	All SQI pins	—	—	10	pF	—

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

TABLE 37-18: SYSTEM TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial				
Param. No.	**Symbol**	**Characteristics**	**Minimum**	**Typical**	**Maximum**	**Units**	**Conditions**
OS51	FSYS	System Frequency	DC	—	200	MHz	USB module disabled
			60	—	200	MHz	USB module enabled
OS55a	FPB	Peripheral Bus Frequency	DC	—	100	MHz	For PBCLKx, 'x' ≠ 4, 7
OS55b			DC	—	200	MHz	For PBCLK4, PBCLK7
OS56	FREF	Reference Clock Frequency	—	—	50	MHz	For REFCLKI1, 3, 4 and REFCLKO1, 3, 4 pins

TABLE 37-19: PLL CLOCK TIMING SPECIFICATIONS

AC CHARACTERISTICS			Standard Operating Conditions: 2.1V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param. No.	**Symbol**	**Characteristics(1)**	**Min.**	**Typical**	**Max.**	**Units**	**Conditions**
OS50	FIN	PLL Input Frequency Range	5	—	64	MHz	ECPLL, HSPLL, FRCPLL modes
OS52	TLOCK	PLL Start-up Time (Lock Time)	—	—	100	µs	—
OS53	DCLK	CLKO Stability(2) (Period Jitter or Cumulative)	-0.25	—	+0.25	%	Measured over 100 ms period
OS54	FVCO	PLL VCO Frequency Range	350	—	700	MHz	—
OS54a	FPLL	PLL Output Frequency Range	10	—	200	MHz	—

Note 1: These parameters are characterized, but not tested in manufacturing.

2: This jitter specification is based on clock-cycle by clock-cycle measurements. To get the effective jitter for individual time-bases on communication clocks, use the following formula:

$$EffectiveJitter = \frac{D_{CLK}}{\sqrt{\frac{PBCLK2}{CommunicationClock}}}$$

For example, if PBCLK2 = 100 MHz and SPI bit rate = 50 MHz, the effective jitter is as follows:

$$EffectiveJitter = \frac{D_{CLK}}{\sqrt{\frac{100}{50}}} = \frac{D_{CLK}}{1.41}$$